

Description

The LY323LA05 is a uni-directional high power TVS diode, utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive data and power line. It complies with IEC 61000-4-2 (ESD), $\pm 30\text{kV}$ air and $\pm 30\text{kV}$ contact discharge. It is assembled into a lead-free SOD-323 package. The small size and high ESD surge protection make it an ideal choice to protect cell phone, digital cameras, audio players and many other portable applications.

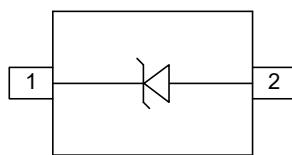
Features

- Low clamping voltage
- Ultra low leakage current
- Operating voltage: 5V
- RoHS compliant
- IEC-61000-4-2 ESD $\pm 30\text{kV}$ Air, $\pm 30\text{kV}$ Contact
- Packaging: 7 inch reel, 3000pcs/reel

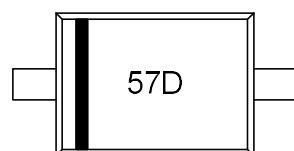
Applications

- Mobile Phones and Accessories
- Power Supply Protection
- Hand Held Portable Applications

Pin Configuration and Marking



Circuit and Pin Schematic



Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)

Parameter	Symbol	Value
Peak Pulse Power (8/20μs)	P_{PP}	1800W
Peak Pulse Current (8/20μs)	I_{PP}	120A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	±30kV ±30kV
Ambient Temperature Range	T_A	-55°C to +125°C
Storage Temperature Range	T_{STG}	-55°C to +150°C

Electrical Characteristics ($T_A=25^\circ\text{C}$)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.
Reverse Working Voltage	V_{RWM}		-	-	5V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	6V	-	-
Reverse Leakage Current	I_R	$V_{RWM} = 5\text{V}$	-	-	1μA
Clamping Voltage	V_C	$I_{PP} = 20\text{A} (8/20\mu\text{s})$	-	-	9.5V
		$I_{PP} = 120\text{A} (8/20\mu\text{s})$	-	-	15V
Junction Capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$	-	450pF	-

Typical Characteristic Curves ($T_A=25^\circ\text{C}$)

Figure 1. Peak Pulse Power Rating Curve

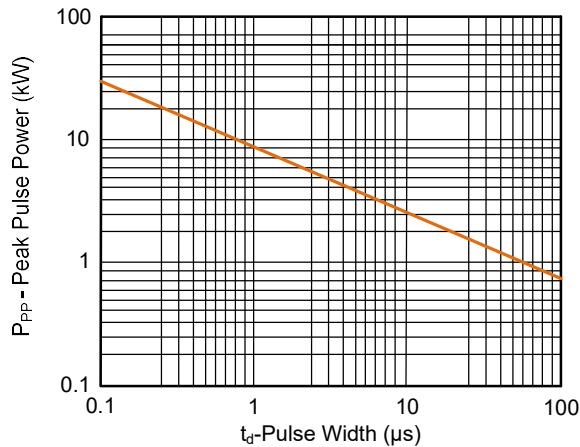


Figure 2. Pulse Derating Curve

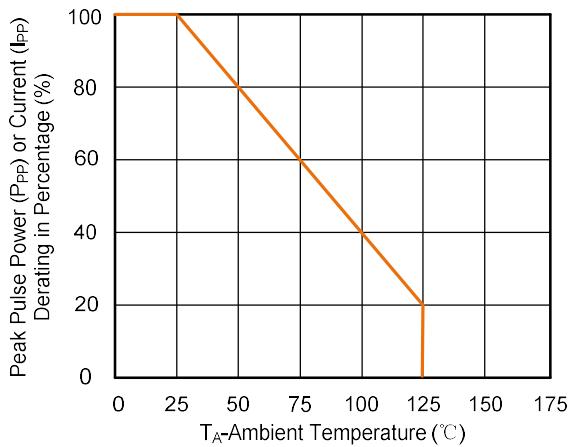


Figure 3. Clamping Voltage vs. Peak Pulse Current

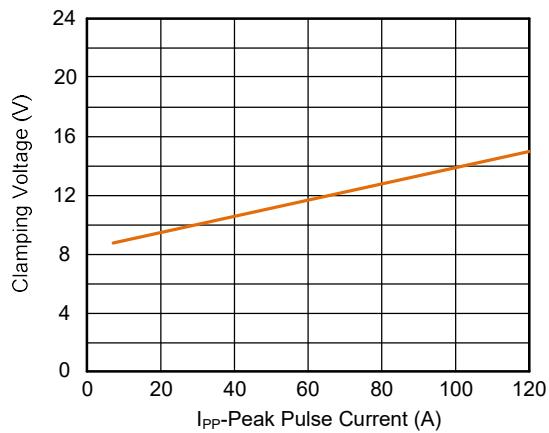


Figure 4. Junction Capacitance vs. Reverse Voltage

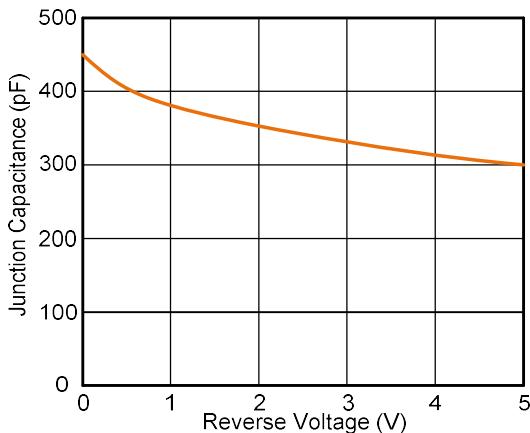


Figure 5. Pulse Waveform (8/20μs)

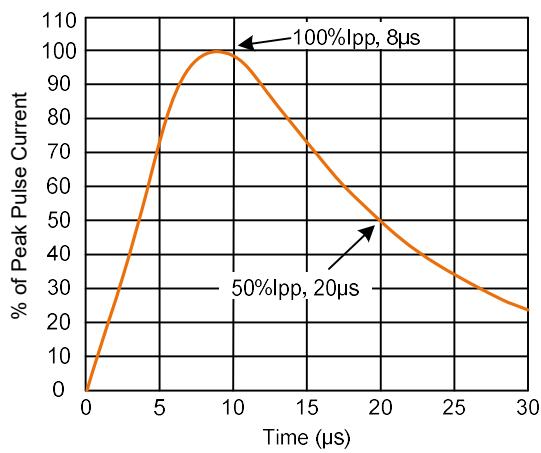
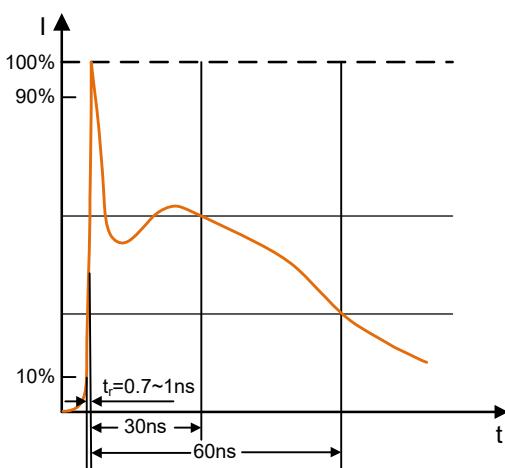
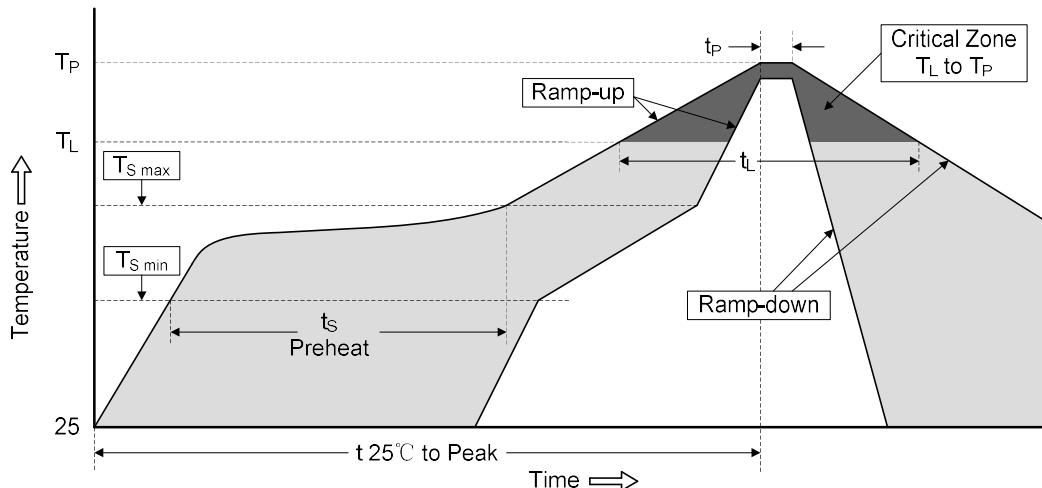


Figure 6. Pulse Waveform (IEC61000-4-2)



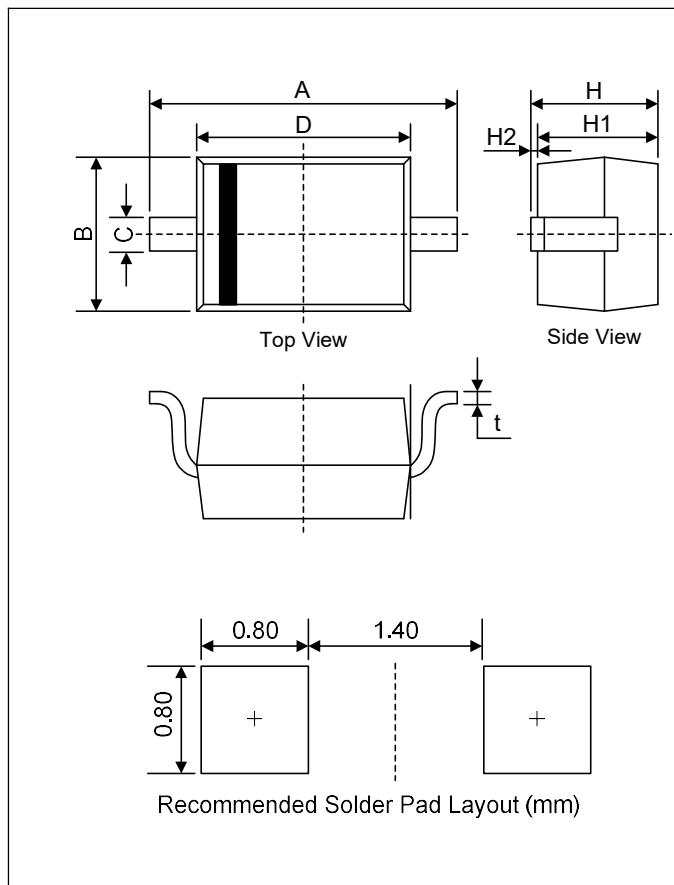
Soldering Parameters

Reflow Soldering



Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat	
-Temperature Min ($T_{S \text{ min}}$)	150°C
-Temperature Max ($T_{S \text{ max}}$)	200°C
-Time (min to max) (t_S)	60-180 seconds
$T_{S \text{ max}}$ to T_L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T_L)	217°C
-Time (t_L)	60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Dimensions (SOD-323)



Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.30	2.80	0.091	0.110
B	1.15	1.40	0.045	0.055
C	0.25	0.40	0.001	0.016
D	1.60	1.80	0.063	0.071
H	0.80	1.10	0.031	0.043
H1	0.80	0.90	0.031	0.035
H2	0.00	0.10	0.000	0.004
t	0.08	0.18	0.003	0.007